

BUT12AX Silicon diffused power transistor Rev. 01 — 16 June 2004

Product data

1. Product profile

2. Pinning information

Table 1: Pinning - SOT186A (TO-220F), simplified outline and symbol

Pin	Description	Simplified outline	Symbol	
1	base (b)		2	
2	collector (c)	mb	2 J	
3	emitter (e)	$\circ \circ \circ$	1	
mb	mounting base; isolated			
		() () () () () () () () () () () () () (
		SOT186A (TO-220F)		



3. Ordering information

Table 2: Ordering information							
Type number Package							
	Name	Description	Version				
BUT12AX	TO-220F	Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3 leads.	SOT186A				

4. Limiting values

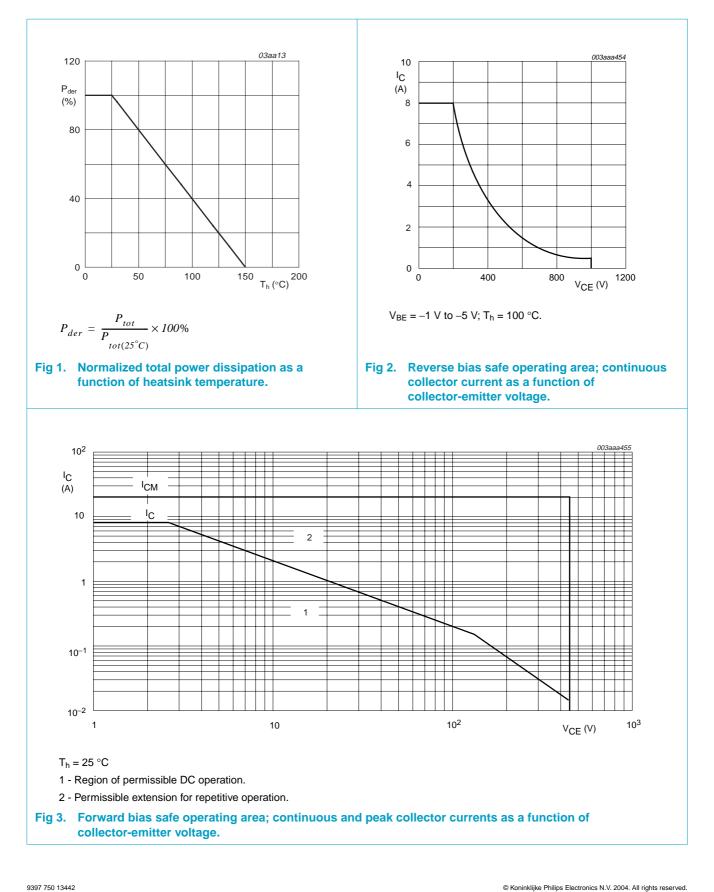
Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CESM}	peak collector-emitter voltage	V _{BE} = 0 V	-	1000	V
V_{CEO}	collector-emitter voltage	base open circuit	-	450	V
I _C	collector current	Figure 2 and 3	-	8	А
I _{Csat}	collector saturation current		-	5	А
I _{CM}	peak collector current	Figure 3	-	20	А
I _B	base current (DC)		-	4	А
I _{BM}	peak base current		-	6	А
P _{tot}	total power dissipation	T _h = 25 °C; Figure 1	[1] _	23	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	+150	°C

[1] Mounted without heatsink compound.

BUT12AX



5. Thermal characteristics

Table 4:	Ihermal	characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	Mounted without heatsink compound	[1]	-	-	5.5	K/W
		Mounted with heatsink compound	[1]	-	-	3.9	K/W
R _{th(j-a)}	thermal resistance from junction to ambient			-	55	-	K/W

[1] External heatsink connected to mounting base.

6. Characteristics

Table 5: Characteristics

 $T_i = 25 \circ C$ unless otherwise specified.

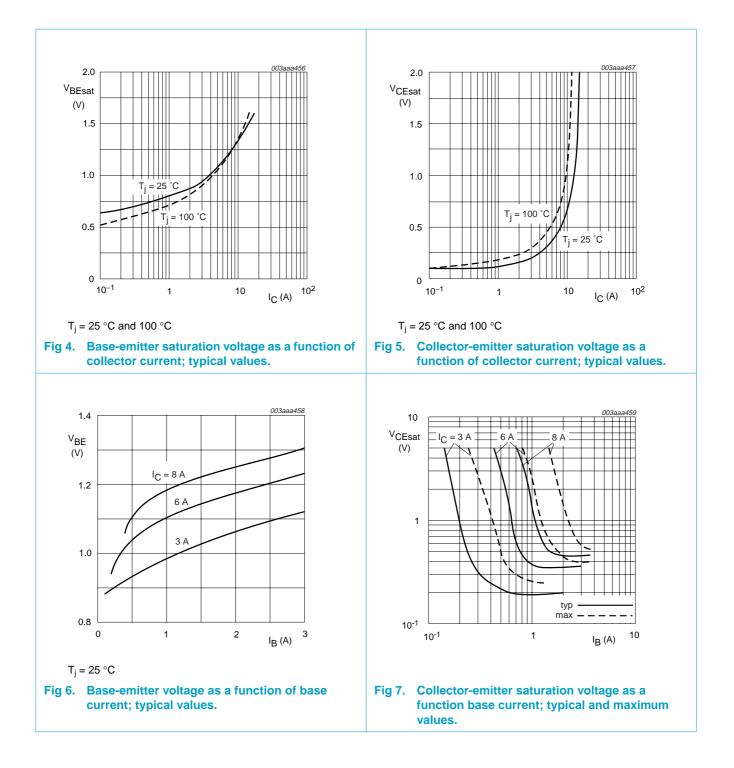
,	,						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	naracteristics						
V _{CEOsus}	collector-emitter sustaining voltage	I _C = 100 mA; I _{Boff} = 0 A; L = 25 mH; Figure 9 and 10		400	-	-	V
V _{CEsat}	collector-emitter saturation voltage	I _C = 5 A; I _B = 1 A; Figure 5		-	-	1.5	V
V _{BEsat}	base-emitter saturation voltage	I _C = 5 A; I _B = 1 A; Figure 4		-	-	1.5	V
I _{CES}	collector-emitter cut-off current	$V_{CE} = V_{CESM}; V_{BE} = 0 V$					
		T _j = 25 °C	[1]	-	-	1	mA
		T _j = 125 °C	[1]	-	-	3	mA
h _{FE}	DC current gain	V _{CE} = 5 V; Figure 8					
		I _C = 10 mA		10	18	35	
		I _C = 1 A		10	20	35	
Dynamic	c characteristics						
t _{on}	turn-on time	I _{Con} = 5 A; I _{Bon} = I _{Boff} = 1 A; resistive load; <mark>Figure 11</mark> and <mark>12</mark>		-	-	1	μs
t _s	carrier storage time	I _{Con} = 5 A; I _{Bon} = I _{Boff} = 1 A; resistive load; Figure 11 and 12	[2]	-	-	4	μs
		$I_{Con} = 5 \text{ A}; I_{Bon} = 1 \text{ A};$ $V_{CL} = 250 \text{ V}; T_{mb} = 100 \text{ °C};$ inductive load; Figure 13 and 14		-	1.9	2.5	μs
t _f	fall time	I _{Con} = 5 A; I _{Bon} = I _{Boff} = 1 A; resistive load; Figure 11 and 12		-	-	0.8	μs
		$I_{Con} = 5 \text{ A}; I_{Bon} = 1 \text{ A}; V_{CL} = 300 \text{ V};$ $T_{mb} = 100 ^\circ\text{C}; \text{ inductive load};$ Figure 13 and 14		-	200	300	ns

[1] Measured with a half-sinewave voltage.

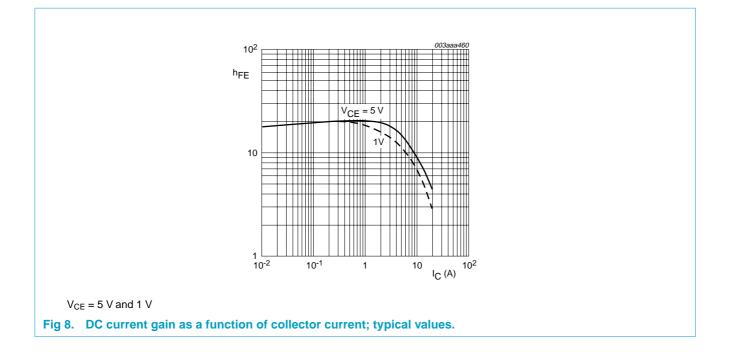
[2] turn-off storage time

4 of 12

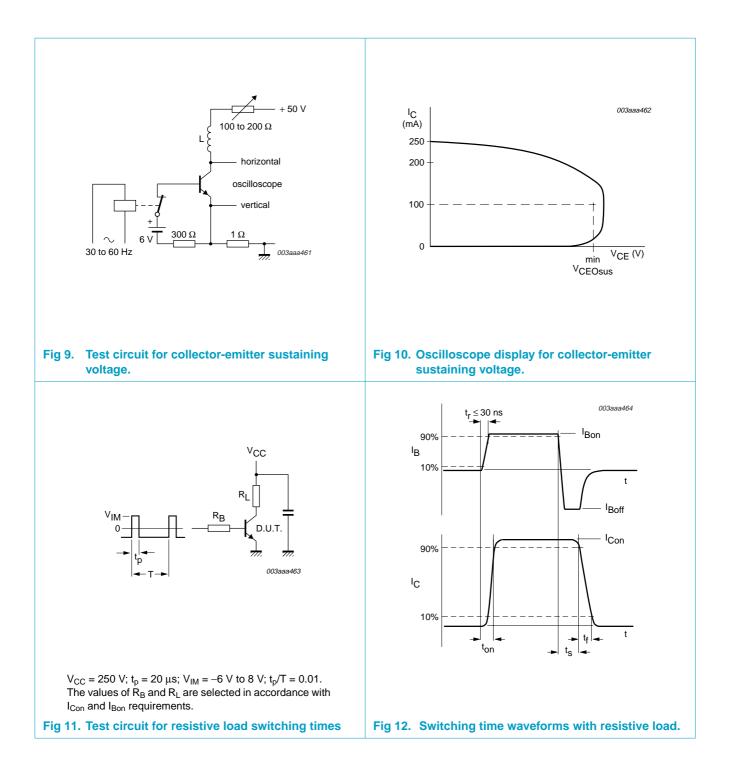
BUT12AX



BUT12AX

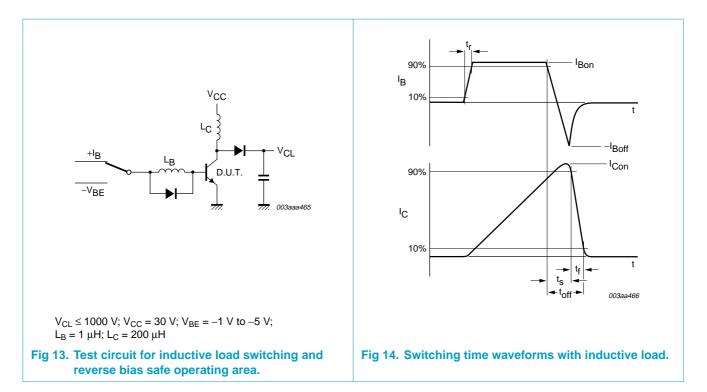


BUT12AX



BUT12AX

Silicon diffused power transistor



7. Isolation characteristics

Table 6:	Isolation characteristics					
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V _{isol(RMS)} M	Peak RMS isolation voltage from all three terminals to external heatsink.	f = 50 to 60 Hz; sinusoidal waveform; RH \leq 65%; clean and dust-free.	-	-	2500	V
C _{c-h}	Capacitance from collector to external heatsink.		-	12	-	pF

BUT12AX

Silicon diffused power transistor

8. Package outline

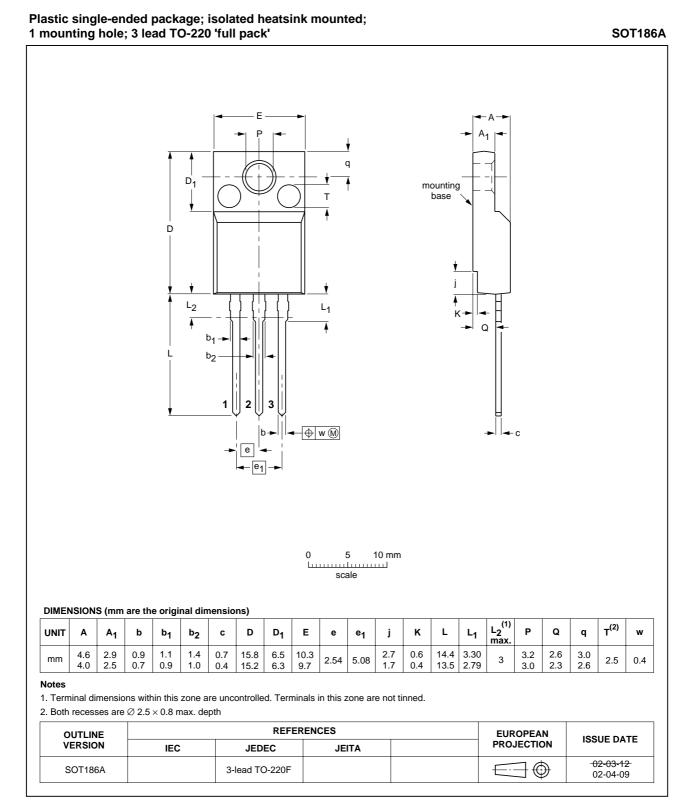


Fig 15. SOT186A (TO-220F).

9397 750 13442 Product data

9. Revision history

Table	7: Revis	ion history	
Rev	Date	CPCN	Description
01	20040616	-	Product data (9397 750 13442)

Silicon diffused power transistor

10. Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2][3]}	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

11. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

12. Disclaimers

Life support — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products - including circuits, standard cells, and/or software - described or contained herein in order to improve design and/or performance. When the product is in full production (status 'Production'), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Contact information

For additional information, please visit http://www.semiconductors.philips.com. For sales office addresses, send e-mail to: sales.addresses@www.semiconductors.philips.com.

Fax: +31 40 27 24825

© Koninklijke Philips Electronics N.V. 2004. All rights reserved.

9397 750 13442

BUT12AX

Silicon diffused power transistor

Contents

1	Product profile
1.1	Description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data
2	Pinning information 1
3	Ordering information 2
4	Limiting values 2
5	Thermal characteristics 4
6	Characteristics 4
7	Isolation characteristics 8
8	Package outline 9
9	Revision history 10
10	Data sheet status 11
11	Definitions 11
12	Disclaimers 11

© Koninklijke Philips Electronics N.V. 2004. Printed in The Netherlands

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Date of release: 16 June 2004



Let's make things better.